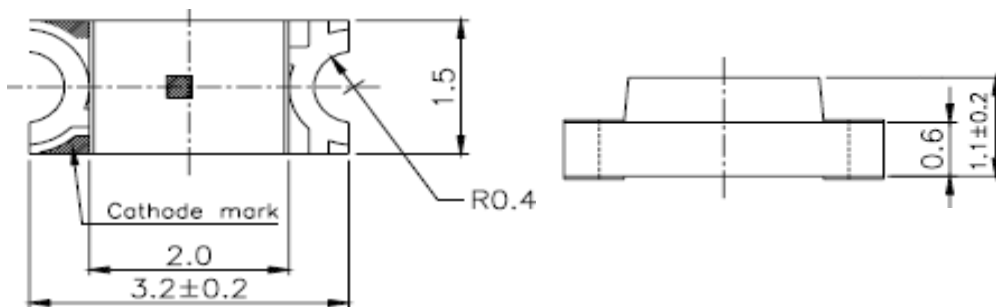




Applications

- Interior automotive lighting
- Optical indicators
- Communication Products
- Backlighting
- Toys

Technical Drawing



Recommended Soldering Pattern

Notes :

All dimensions in mm tolerance is $\pm 0.1\text{mm}$ unless otherwise noted.

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Absolute Maximum Ratings

Item	Symbol	InGaN	Unit
Power Dissipation	P_D	---	mW
DC Forward Current	I_F	---	mA
Pulsed Forward Current	I_{FP}^*	---	mA
Reverse Voltage	V_R	---	V
Operating Temperature	T_{OP}	---	°C
Storage Temperature	T_{ST}	---	°C

* 0.1 msec pulse, 10% duty cycle

Electrical / Optical Characteristics

$I_F=20mA$

Ermitting Color	Green		
Material	InGaN		
Forward Voltage	typ.	2.9	V_F
	max.	3.5	V_F
Wavelength typ.	λ_D	520	nm
	λ_P	530	nm
	$\Delta\lambda$	---	nm
Color Temperature	min.	---	K
	max.	---	K
Luminous Intensity *	min.	300	mcd
	typ.	500	mcd
Reverse Current	max.	---	μA
Viewing Angle	2 Θ 1/2	120	

* Per NIST standards

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Directive Characteristics

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Curvs

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Solder Condition

Lead Free Solder



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Packing Specifications



Reel Specifications



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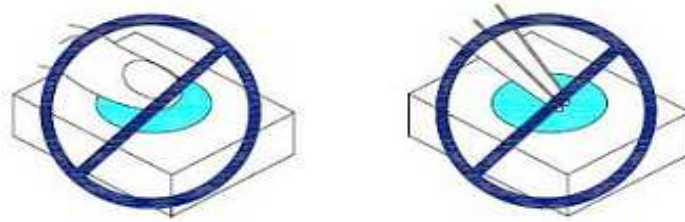
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



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4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



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Color table curve



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